

HSP

NOTES:

Current Rating: 1.0AMP
 Withstand Voltage: 500V AC/DC
 Contact Resistance: 20mΩ Max
 Insulation Resistance: 1000MΩMin
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au or Sn over Ni
 Insulator Material: PA6T+30%G, F UL94V-0

Ordering Information

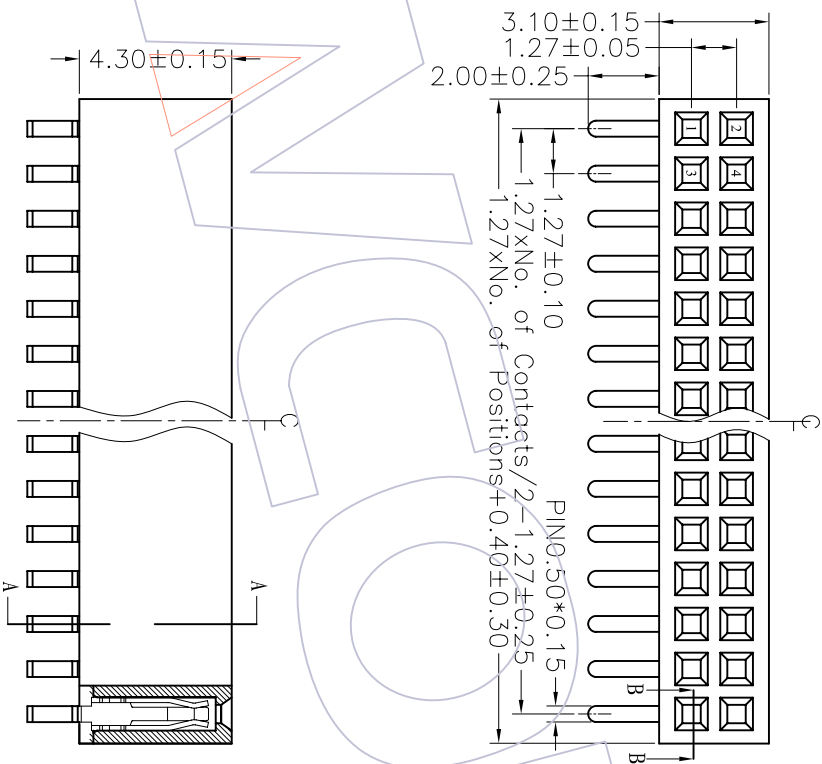
2344 - 2 XX R XX CUNT 1

No. of Pins per ROW: 42=50Pin

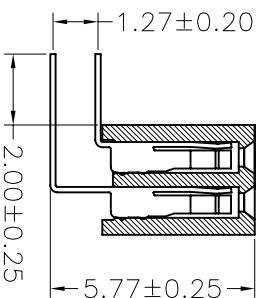
Contact Plating:
 Co=Gold Flash
 G1=3μ"Gold
 G2=5μ"Gold
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold

Packaging:
 T=Tube

SP=Gold Flash/Tin
 S1=3μ"Gold/Tin
 S2=5μ"Gold/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin

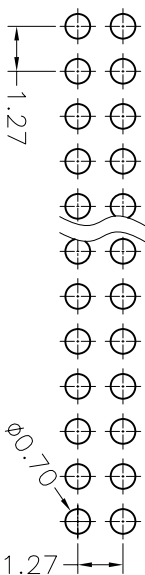


SECTION B-B



SECTION A-A

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/02/16	NEW			X.X ±0.40	DESIGN	3:1	2344-2XXRXXCUNT1	FH1. 27mm DUAL 90° H=4.30
					X.XX ±0.25	CHECK	mm		
					X.XXX ±0.15		A4		
					Angle ± .3°		1/1		
					DIM TOL	APPROVE			
						PROJ.			
								Customer NO.	

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 WAVE HARDWARE ELECTRONICS CO.,LTD